







### Application Note NC08703

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### 1 SUMMARY

This report gives a description of a wideband push-pull amplifier for the frequency range 1.6 - 28 MHz. The amplifier has been designed around 2 MOS transistors BLF177 which operate in class-AB at V<sub>DS</sub> = 50 V and I<sub>DQ</sub> = 0.5 A/transistor.

The main properties at  $P_O = 300$  W are:

Powergain: 22 to 23 dB

Efficiency: 52.5 to 61%

Return losses input:  $\leq -15.5 \text{ dB}$ 

2nd harmonics:  $\leq -25 \text{ dB}$ 

3rd harmonics:  $\leq -16 \text{ dB}$ 

IMD at  $\mathsf{P}_\mathsf{O}$  = 300 W PEP:  $\leq$  –33 dB.

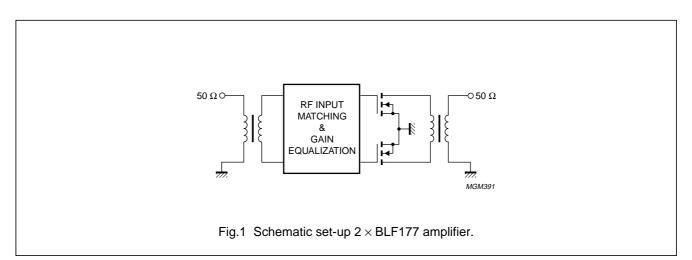
### 2 INTRODUCTION

The BLF177 is an RF Power MOS transistor for the HF and VHF range in a 4 leads flange SOT121 encapsulation. For the frequency range 1.6 - 28 MHz a wideband push-pull power amplifier has been developed with  $2 \times$  BLF177 having an output power of 300 W PEP at an intermodulation distortion level below -30 dB. The transistors operate in class-AB at V<sub>DS</sub> = 50 V and a quiescent current of 0.5 A each.

### 3 DESIGN OF THE AMPLIFIER

### 3.1 General

The schematic set-up is given in Fig.1.



The two balance to unbalance transformers are applied to split the single ended input into 2 out of phase driving ports and to add the 2 out of phase output ports into one single ended output. The transformers have an impedance transformation ratio of 4 : 1 and match the low-ohmic in- and output impedance of the transistors to the 50  $\Omega$  system impedance. At the input a special circuit takes care of a good input matching and a flat powergain over the whole bandwidth.

### 3.2 Output circuit

#### 3.2.1 LOAD IMPEDANCE

The output impedance of each transistor can be represented as a combination of the output capacitance  $C_{oss}$  and the optimum load resistance. Because of the larger drain voltage swing the effective output capacitance  $C_O$  is appr. 15% higher than the value of  $C_{oss}$ . So  $C_O = 1.15 \times 190 \approx 220$  pF. The optimum load resistance for class-AB can be determined with formula:

### $\mathsf{R}_{\mathsf{L}} = (0.85 \times \mathsf{V}_{\mathsf{DS}})^2 / (2 \times \mathsf{P}_{\mathsf{O}})$

For  $V_{DS} = 50$  V and  $P_O = 150$  W we get  $R_L = 6 \Omega$ . To keep the transformer simple a transformation ratio of 4 or 9 is preferable. A ratio of 4 gives a load impedance of  $50/4 = 12.5 \Omega \rightarrow 6.25 \Omega$  for each transistor. This is very near to the optimum load resistance.

#### 3.2.2 OUTPUT TRANSFORMER

The output transformer has to transform the 50  $\Omega$  asymmetrical impedance to the 2 × 6.25 = 12.5  $\Omega$  symmetrical load impedance. The reactance ( $\omega$ L) of the shunting inductance at 1.6 MHz has been chosen at 4 times 50  $\Omega$  = 200  $\Omega$ . So the inductance is 20  $\mu$ H. The transformer has been wound on a ferrite toroid of 4C6 material. Dimensions: 36 × 23 × 15 mm (D × d × h) which gives a volume (A.1) = 8.97E-6m<sup>3</sup>.

Because the power handling of one toroid is critical two transformers in parallel with an inductance of 40  $\mu$ H each have been chosen.

 $\begin{array}{l} n_{sec} = SQR((L.1)/(\mu o \times \mu r \times A)) \\ n_{sec} = SQR((40E-6 \times 9.2E-2)/(4\pi E-7 \times 120 \times 97.6E-6)) = 15.8 \ turns. \\ \text{So } n_{pr} = 8 \ turns \ and \ n_{sec} = 16 \ turns. \end{array}$ 

For each transformer V<sub>max</sub> depends on the power over 100  $\Omega$ . V<sub>max</sub> = SQR(2 × P<sub>O</sub> × R<sub>L</sub>) = SQR(2 × 150 × 100) = 173.2 V

 $B_{max}$  depends on the parallel loss resistance at 1.6 MHz; for a power loss of 1%:  $B_{max} = 1.3E - 2T$ . The volume A.1 needed per core is: A.1 =  $(V_{max}/(\omega \times B_{max}))^2(\mu_o \times \mu_r)/L$ .

A.1 =  $(1.73.2/(2\pi \times 1.6E + 6 \times 0.013))^2(4\pi E - 7 \times 120)/40E - 6 = 6.62E - 6 m^3$ .

Each of the toroids has a volume of  $8.97E - 6 \text{ m}^3$ . Figure 7 shows one of the two parallel connected output transformers. On each toroid the primary winding has 8 turns of copperfoil (width 5 mm and thickness 0.05 mm). The secondary winding has 16 turns of 2 enamelled copper wires (0.6 mm) in parallel.

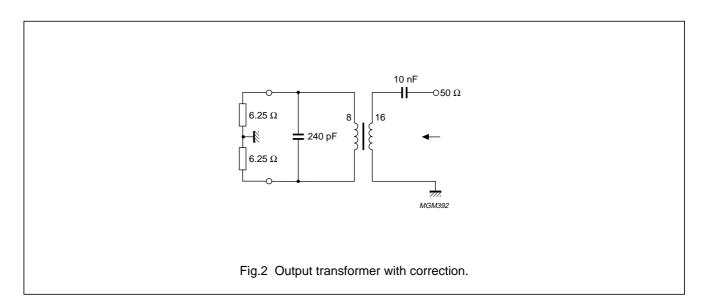
So each primary turn has been covered with 2 secondary turns which means 4 wires of 0.6 mm. Both windings are isolated with PTFE-foil (thickness 0.1 mm). To reduce the stray-inductance the transformer has been wound as follows:

- 1. The primary has been wound evenly around the periphery of the toroid
- 2. With the secondary the same has been done with the first 8 turns; the second part of 8 turns has been wound in between the first part. So the secondary has been wound twice around the core.

The measured secondary inductance of each transformer is 38  $\mu$ H and L<sub>str</sub> = 300 nH.

With the aid of a network analyser the parallel combination of these 2 transformers has been corrected. For the higher frequencies at the low-ohmic side a parallel capacitor of 240 pF and for the lower frequencies at the high-ohmic side a series capacitor of 10 nF give return losses below –21 dB over the whole frequency range (see Fig.2).

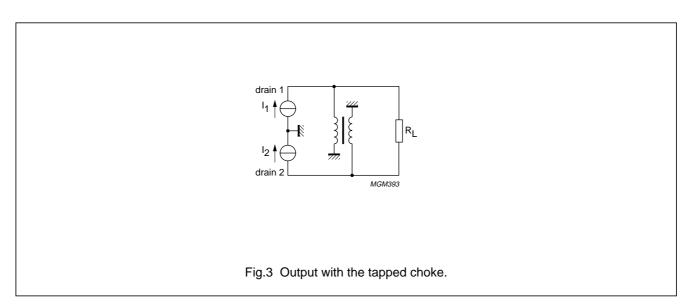
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Replacing the transistors by resistors of 6.25  $\Omega$  the return loss can be measured at the 50  $\Omega$  side. Figure 11 gives the return losses of the parallel combination of the two transformers before and after the correction.

### 3.2.3 The tapped choke

The chokes in the drain circuits are wound around a common ferrite rod of 4B1 material. Dimensions:  $50 \times 10$  mm (l × d). Figure 3 gives a schematic electrical circuit of the output.



Between both drains the impedance for the even harmonics depends on the coupling factor between both windings. If the coupling factor amounts to 1 both drains will be short circuited for the even harmonics.

Because the voltage over one winding is equal to half of the voltage between both drains, the total inductance between both drains is 4 times the inductance of one winding.

The reactance of the shunting inductance at 1.6 MHz has been chosen at 4 times 12.5  $\Omega$  = 50  $\Omega$ .

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So the inductance between both drains is 5  $\mu$ H, this means for one winding an inductance of 1.25  $\mu$ H. According to the Philips Data Handbook *"MA01 on soft ferrites of 1996, the effective permeability"* of a rod with 1/d = 5 and  $\mu_r$  = 250 is appr. 20.

The number of turns can be calculated with:

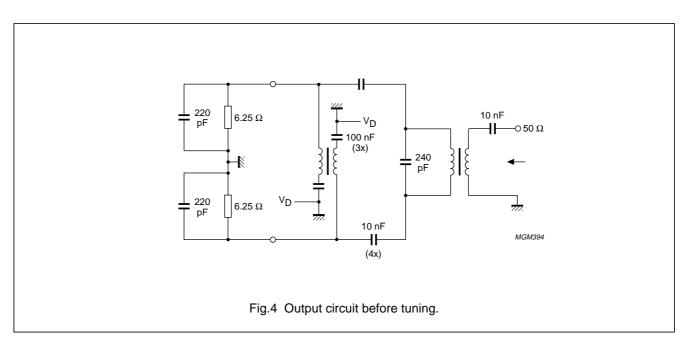
### $n = SQR(L.1/(\mu_o \times \mu_r \times A))$

n = SQR( $1.25E - 6 \times 50E - 3/(4\pi E - 7 \times 20 \times \frac{1}{4}\pi(10E - 3)^2)$  = 5.6 turns. In practice 6 twisted turns of the primary and secondary windings have been wound around the rod. Figure 8 shows the tapped choke. To increase the coupling factor each winding consists of 2 enamelled copper wires (0.8 mm) in parallel. The measured inductance is 1.275 µH.

### 3.2.4 TUNING OF THE OUTPUT CIRCUIT

For an optimum alignment of the output circuit the 2 transistors have been replaced by dummies consisting of the parallel connection of a resistance and a capacitance. The resistance is equal to the optimum load resistance and the capacitance to the output capacitance (see Section 3.2.1).

Tuning of the output circuit has been carried out by measuring the return losses at the output with a network analyser under swept conditions (see Fig.4).



The measured return losses should be as low as possible by changing the correction capacitors. Figure 12 shows the return losses of the output before and after tuning. For optimum results the capacitance across the primary winding of the output transformer has been reduced from 240 to 150 pF and the low frequency correction capacitor of 10 nF at the output has been changed to an inductance of 100 nH. The last change can be explained as follows:

- 1. The low frequency compensation is taken over by the coupling capacitors between the drain choke and the impedance transformer
- 2. The function of the transformer is not only impedance matching but also transfer from balanced to unbalanced. The latter makes that the interwinding capacitance has more influence. This is so much that a series inductance at the output is needed for high frequency compensation.

### 3.3 Input circuit

#### 3.3.1 INPUT IMPEDANCE

The input impedance and gain of the transistor can be determined with the aid of a computer model of the BLF177. Table 1 shows the calculated gain and impedances for the frequency range 1.6 to 28 MHz.

BLF177 Vds = 50 V Po = 150 W Class-AB.

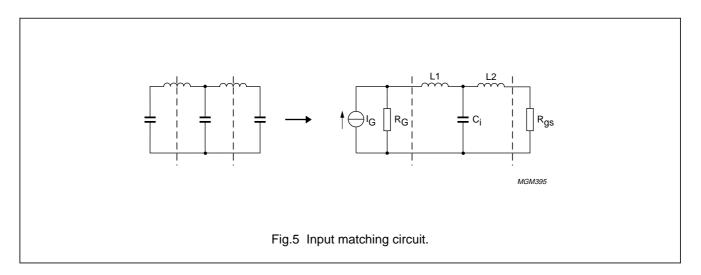
Table 1 Calculated gain and impedances of the BLF1	Table 1	ulated dain and impedances (	of the BLF177
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f (MHz)	G (dB)	INP.IMP. (Ω)	LOAD IMP. (Ω)
1.6	54.70	2.29 – j133.58	6.23 + j.07
2.5	50.82	2.29 – j85.50	6.23 + j.12
3.5	47.90	2.29 – j61.09	6.23 + j.16
5.0	44.80	2.29 – j42.78	6.22 + j.23
7.0	41.88	2.29 – j30.58	6.21 + j.32
10.0	38.78	2.29 – j21.45	6.18 + j.46
14.0	35.85	2.29 – j15.37	6.13 + j.64
20.0	32.75	2.29 – j10.84	6.03 + j.89
24.0	31.17	2.29 – j9.09	5.95 + j1.05
28.0	29.83	2.29 – j7.85	5.85 + j1.20

By adding a gate-source resistor of 6.25  $\Omega$  the power gain reduces from 29.8 to 23.3 dB at 28 MHz.

### 3.3.2 INPUT MATCHING CIRCUIT

As mentioned in Section 3.1 a special circuit matches the input impedance of each transistor to the 6.25  $\Omega$  of the input transformer. The matching network chosen can be treated as the half of a double  $\pi$ -section as described in Ref.1. Removing the in- and output capacitance the circuit changes in a T-section with C<sub>i</sub> as capacitor and 2 inductances with a value of half the inductances of the double  $\pi$ -section (see Fig.5).



C<sub>i</sub> represents the input capacitance of the BLF177 and can be calculated from the input impedance of Table 1. For 7 MHz: C<sub>i</sub> =  $1/(2\pi \times 7E + 6 \times 30.58) = 744 \text{ pF}.$ 

Across this capacitor a constant voltage versus frequency from 1.6 up to 28 MHz has to be developed. Provided C<sub>i</sub> is an ideal capacitance the dimensioning of this network is as follows:

 $R_G = R_{gs}$  must be appr. 6  $\Omega$  to obtain low I.M. distortion and good stability. This appeared during the development of the narrow band testcircuit as given in the BLF177 publication data. To judge whether this value is also acceptable for wideband operation we calculate the product:

 $W_c \times C_i \times R_{gs}$  in which  $\omega_c$  is the maximum angular frequency.

Doing so we find:

 $2\pi \times 28E + 6 \times 744E - 12 \times 6.25 = 0.818$ 

 $R_{gs}$  has been chosen 6.25  $\Omega$  for the ease of transformation. Comparing the value of this product with the one given in Ref.2 we see that with a double  $\pi$ -section we can easily reach a bandwidth of 50 MHz. Therefore we have simplified the network as described above. Continuing the calculation we find:

 $L = 0.997 R_G/\omega_c = 35.4 nH$  (So L1 = L2 = 17.7 nH)

With the computer model mentioned in Section 3.3.1 a gain of 22.3 dB has been calculated with  $R_{gs}$  = 6.25  $\Omega$ .

Starting from this 22.3 dB gain,  $L_1 = L_2 = 17.7$  nH and  $R_{gs} = 6.25 \Omega$  the input VSWR and gain deviation have been calculated (see Table 2).

Initial results Rs =  $6.250 \Omega$ ; Gs = 22.300 dBPar.LR: L = 17.700 nH; R =  $6.250 \Omega$ Ser.Ind.: L = 17.700 nH

 Table 2
 Results before optimization

f (MHz)	VSWR	dG (dB)
1.6	1.010	1.440
2.5	1.016	1.435
3.5	1.023	1.431
5.0	1.032	1.419
7.0	1.046	1.402
10.0	1.068	1.354
14.0	1.100	1.265
20.0	1.161	1.075
24.0	1.214	.910
28.0	1.281	.703

Before optimization the maximum VSWR = 1.28 and the gain = 22.7 dB  $\pm$  0.37 dB. To achieve a maximally flat gain and a low input VSWR a computer optimization program has been used. This optimization results in a gain of 23.3 dB with a maximum  $\Delta$ Gain =  $\pm$ 0.09 dB and a VSWR  $\leq$ 1.09, see Table 3. For these results L<sub>1</sub> has been changed from 17.7 nH to 9 nH and L<sub>2</sub> from 17.7 nH to 21.1 nH. the R<sub>gs</sub> has been decreased from 6.25  $\Omega$  to 5.7  $\Omega$ .

Final results Rs =  $6.250 \Omega$ ; Gs = 23.300 dBPar.LR: L = 21.079 nH; R =  $5.749 \Omega$ Ser.Ind.: L = 8.950 nH

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#### Table 3 Results after optimization

f (MHz)	VSWR	dG (dB)
1.6	1.087	.072
2.5	1.087	.071
3.5	1.087	.074
5.0	1.086	.076
7.0	1.085	.084
10.0	1.082	.087
14.0	1.076	.086
20.0	1.059	.056
24.0	1.047	.006
28.0	1.044	087

### 3.3.3 INPUT TRANSFORMER

The input transformer is simular to the output transformer. It transforms the asymmetrical system impedance to the  $2 \times 6.25 \Omega = 12.5 \Omega$  symmetrical source impedance. However the lower power handling (<3 W) justifies a toroid of 4C6 material with smaller dimensions:  $14 \times 9 \times 5$  mm (D × d × h) which gives a volume A.1 = 0.445E - 6 m<sup>3</sup>. As described in Section 3.2.2 the primary winding can be calculated for L = 20  $\mu$ H.

$$n_{pr} = SQR((L.1)/(\mu_o \times \mu_r \times A))$$

 $n_{pr} = SQR((20E - 6 \times 3.55E - 2)/(4\pi E - 7 \times 120 \times 12.54E - 6) = 19.4 \text{ turns. With } n_{pr} = 20 \text{ turns and a transformation ratio of } 4 : 1 \text{ the } n_{sec} = 10 \text{ turns.}$ 

 $V_{max} = SQR(2 \times P_i \times R_S) = 17.3 \text{ V} \text{ and } B_{max} = 0.013T.$ 

The needed core volume A.1 is:

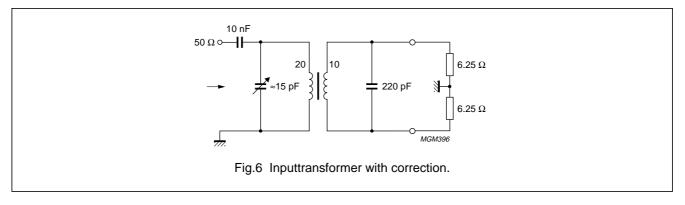
A.1 =  $(V_{max}/(\omega \times B_{max}))^2 \times (\mu_o \times \mu_r)/L$ 

A.1 =  $(17.3/(2\pi \times 1.6E + 6 \times 0.013)^2 \times (4\pi E - 7 \times 120)/20E - 6 = 0.14E - 6 \text{ m}^3$ 

The core used has a volume of  $0.445E - 6m^3$ .

Figure 9 shows the input transformer. The secondary winding has 10 turns of copperfoil (width 2 mm, thickness 0.05 mm). The primary winding has 20 turns of enamelled copper wire (0.5 mm). Each secondary turn has been covered with 2 primary turns with a PTFE foil of 0.1 mm thickness as isolation between the 2 windings. The method of winding is the same as described for the output transformer in Section 3.2.2. The measured inductance is 20.95  $\mu$ H and L<sub>str</sub> = 250 nH.

The correction method used for the input transformer is the same as described already in Section 3.2.2 (see Fig.6).



The transformer has been corrected with parallel capacitors for the higher frequencies and a series capacitor for the lower frequencies. Figure 13 gives the return losses before and after the correction.

### 3.3.4 TUNING OF THE INPUTCIRCUIT

For the practical tuning of the input circuit each transistor has been adjusted at  $V_{DS}$  = 50 V and a quiescent current of 0.5 A.

The gain and input return losses have been measured in the frequency range 1.6 up to 35 MHz. The best results have been achieved by changing the secondary correction capacitor of the inputtransformer from 220 to 30 pF and the primary correction trimmer from  $\approx$  15 pF to  $\approx$  20 pF. The low frequency correction capacitor at the input has been removed. The inductance in serie with R<sub>gs</sub> has been increased from 21.6 to 35 nH. Figure 14 gives the complete circuit diagram of the wide band amplifier with 2 BLF177 transistors. Table 5 gives the corresponding parts list.

### 4 CONSTRUCTION OF THE AMPLIFIER

For the printed circuit board double Cu-clad epoxy fibre glass has been used with a thickness of 1/16" and  $\varepsilon_r = 4.5$ . The position of the components is on one side and the other side serves as a groundplane. Connections to the groundplane have been made with rivets and with straps under the source leads and at the edges of the PC-board on the in- and output side.

The printed circuit board has been attached to a solid copper plate  $(145 \times 120 \times 10 \text{ mm})$  which functions as a heatsink. Around the position of both transistors a tube has been soldered in the copper plate to controle the temperature by means of a watercooling system. For a good thermal contact between heatsink and transistors heatsink compound has been used.

Figure 15 shows the lay-out of the amplifier. The transformers have been fastened above the printed circuit board by means of accessories of Delrin material.

These accessories have been attached through the PC-board in the copper plate.

### 5 MEASURED PERFORMANCE

### 5.1 Single tone measurements

Figures 16 to 20 show at a constant outputpower of 300 W at 2 heatsink temperatures the gain, efficiency, input return losses, 2nd and 3rd harmonics at the output as a function of the frequency. In the range 1.6 to 28 MHz the gain is 22 to 23 dB, the efficiency 52.5 to 61%, the input return losses are below -15.5 dB, the second harmonics better then -25 dB and the third harmonics below -16 dB.

At a heatsink temperature of 70 °C the gain decreases about 1.5 dB. The heatsink temperature has only little influence on the other parameters. Figures 21 to 23 shows at 4 frequencies the output power as a function of the input power and the gain and efficiency versus outputpower.

Above 10 MHz the efficiency decreases about 6%. At 20 MHz the gain decreases above  $P_0 = 200$  W. At other frequencies this decrease starts at  $P_0 = 300$  W.

### 5.2 Two tone measurements

The two tone measurements have been carried out with 2 carriers with a frequency distance of 1 KHz. Figure 24 to 27 give as a function of the frequency the gain, efficiency, 3rd order distortion and 5th order distortion at 4 output levels. Over the whole frequency range the gain variation is less than 1 dB at each power level. At  $P_0 = 300$  W PEP the efficiency is at least 40%, the 3rd order distortion  $\leq$ -33 dB and the 5th order distortion  $\leq$ -38 dB.

Figures 28 and 29 give the 3rd and 5th order distortion versus output power at 4 frequencies.

To verify the choice of  $I_{DQ} = 1$  A the 2nd and 3rd order distortion have been measured versus  $I_{DQ}$ . These measurements have been carried out at the most critical frequency and output level of 20 MHz and 30 W PEP resp. Figure 30 shows that  $I_{DQ} = 1A$  for both transistors together was a good choice.

### 6 BALANCED CIRCUIT

As shown in Table 4 there is a certain amount of unbalance between both drain currents at RF operation. It is possible to improve this by using baluns in front of the input transformer and after the output transformer.

<b>Table 4</b> Drain currents at $P_0 = 500 \text{ W}$	Table 4	Drain currents at $P_0 = 300 \text{ W}$
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f (MHz)	I <sub>D1</sub> (A)	I <sub>D2</sub> (A)
1.6	5.2	4.8
5	5.1	4.75
10	5.25	4.8
15	5.3	4.95
20	5.7	5.3
25	6.2	5.25
30	5.85	5.15

### 7 CONCLUSIONS

This report shows that it is possible to design a wideband push-pull amplifier with 2 BLF177 MOS transistors having a very good performance.

The main properties are:

- Bandwidth: 1.6 to 28 MHz
- V<sub>DS</sub>: 50 V
- I<sub>DQ</sub>: 1 A
- Gain at  $P_0 = 300$  W: 22 to 23 dB
- Efficiency at P<sub>O</sub> = 300 W: 52.5 to 61%
- Return losses input at P<sub>O</sub> = 300 W: ≤–15.5 dB
- 2nd harmonics output at P<sub>O</sub> = 300 W: ≤–25 dB
- 3rd harmonics output at  $P_0 = 300 \text{ W}$ :  $\leq$ -16 dB
- IMD at  $P_O = 300$  W PEP:  $\leq -33$  dB.

### 8 REFERENCES

G. Lukkassen Application report NCO8602 A wideband power amplifier (25 to 110 MHz) with the MOS transistor BLF245.

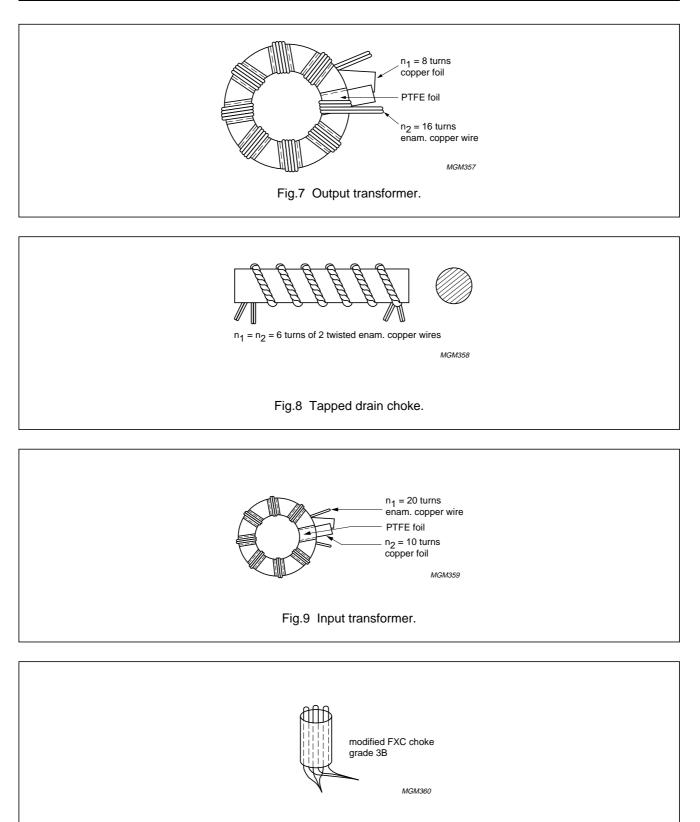
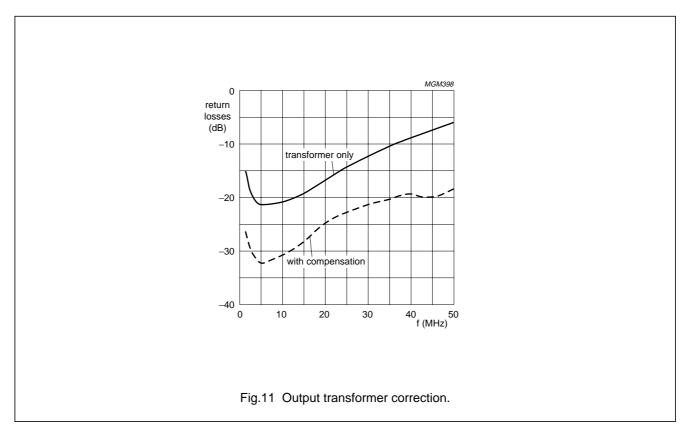
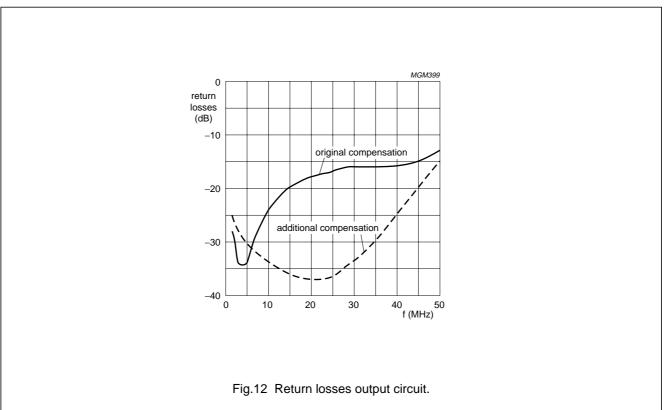
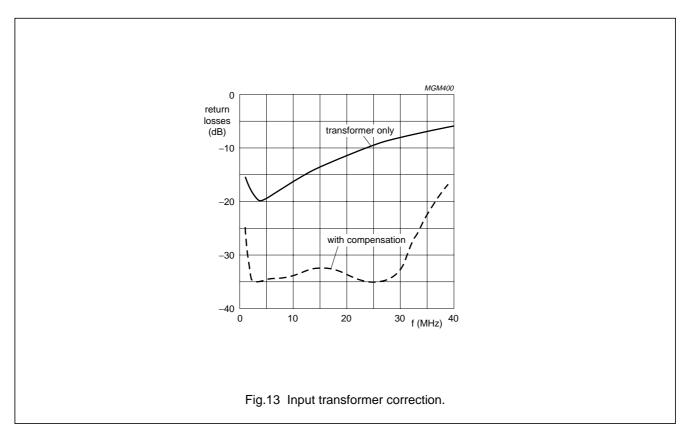
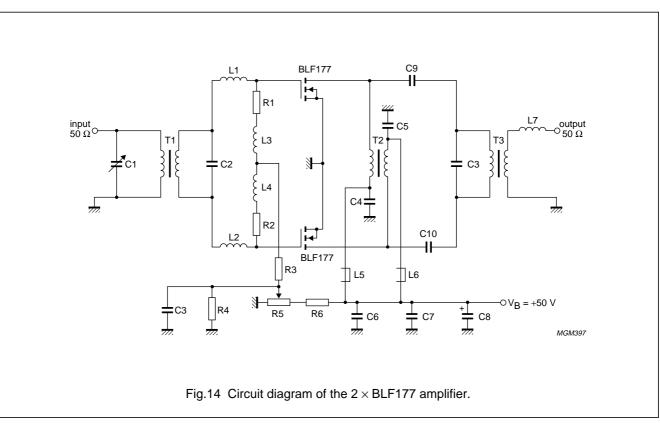


Fig.10 Decoupling choke.









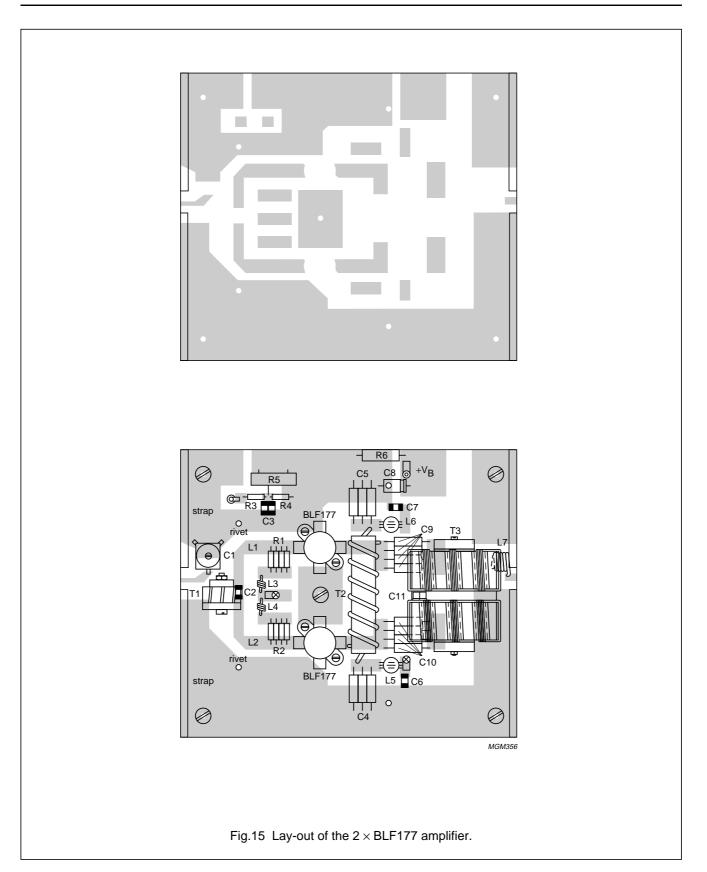
### Table 5 Parts list of the wide band push-pull amplifier with 2 × BLF277 (1.6 to 28 MHz); note 1

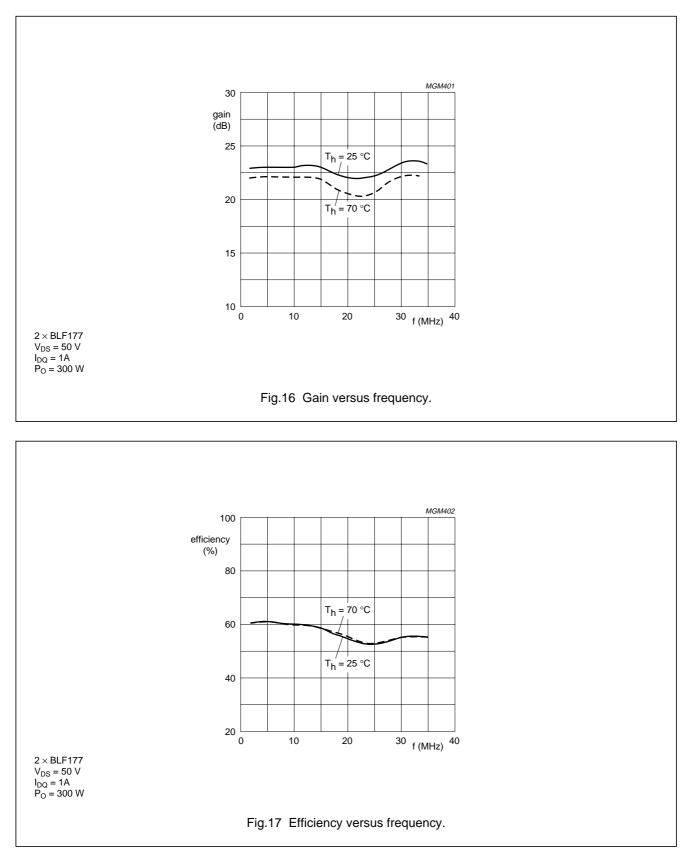
C1	5 – 60 pF film dielectric trimmer (cat.nr.: 2222 809 08003)
C2	30 pF multilayer chip capacitor; note 2
C3	2 × 100 nF multilayer chip capacitor (cat.nr.: 2222 852 47104)
C4 = C5	3 × 100 nF metallized film capacitor (car.nr.: 2222 368 21104)
C6 = C7	100 nF multilayer chip capacitor (cat.nr.: 2222 852 47104)
C8	10 μF (63 V) electrolytic capacitor (cat.nr. 2222 030 28109)
C9 = C10	$4 \times 10$ nF metallized film capacitor (cat.nr. 2222 368 51103)
C11	$2 \times 75$ pF multilayer chip capacitor; note 2
L1 = L2	$\approx$ 9 nH, printed inductance; I = 47 and w = 6 mm
L3 = L4	35 nH, 3 turns enamelled Cu-wire (0.7 mm) int.dia.: 3 mm, I = 2.35 mm
L5 = L6	2.2 μH, 1 turns through modified Ferroxcube choke grade 3B (cat.nr.: 4312 020 36642); see Fig.10
L7	100 nH, 5 turns enamelled Cu-wire (0.8 mm) int.dia.: 5 mm, 1 = 6.1 mm
R1 = R2	5.9 $\Omega$ ; 4 metal film resistors of 23.7 $\Omega$ (0.4 W) in parallel (cat.nr.: 2322 151 72379)
R3	1 kΩ, metal film resistor (0.4 W) (cat.nr.: 2322 151 71002)
R4	1 MΩ, metal film resistor (0.4 W) (cat.nr.: 2322 151 71005)
R5	500 $\Omega$ , Cermet potentiometer (0.75 W)
R6	5.6 kΩ, metal film resistor (1 W) (cat.nr.: 2322 153 55622)
Τ1	input transformer: $n_{pr} = 20$ turns enamelled Cu-wire (0.5 mm) $n_{sec} = 10$ turns copper foil (width 2 mm), thickness 0.05 mm) wound around toroidal core, grade 4C6, dimensions: $14 \times 9 \times 5$ mm (cat.nr. 4322 020 97181) see Fig.9
T2	drain choke: 6 turns of twisted pairs of 0.8 mm Cu-wires (each winding consists of 2 wires in parallel) wound on a Ferroxcube rod, grade 4B1, dimensions $10 \times 50$ mm, see Fig.8
Т3	$n_{pr} = 8$ turns copper foil (width 6 mm, thickness 0.05 mm) $n_{sec} = 16$ turns of 2 enamelled Cu-wires (0.6 mm) in parallel wound around toroidal core, grade 4C6, dimensions: $36 \times 23 \times 15$ mm (cat.nr. 4322 020 97201) see Fig.7; 2 of these transformers in parallel form the complete outputtransformer

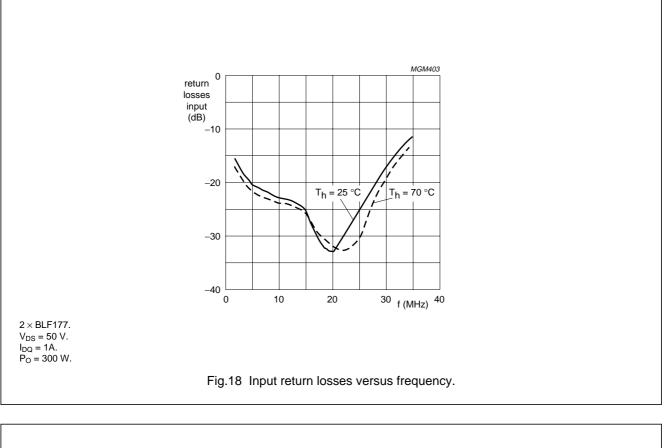
### Notes

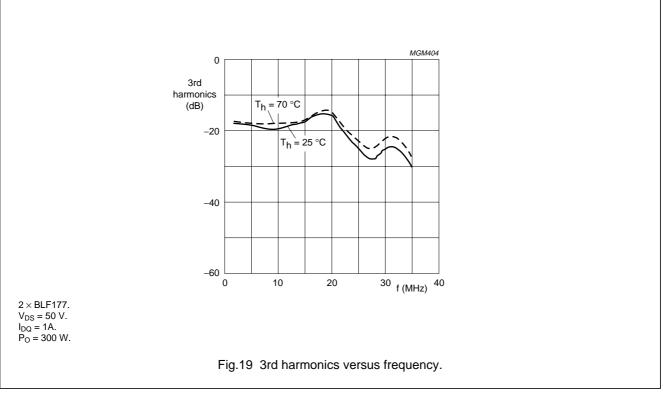
1. PC-board: double Cu-clad, 1/16" epoxy fibre glass ( $\epsilon_r$  = 4.5)

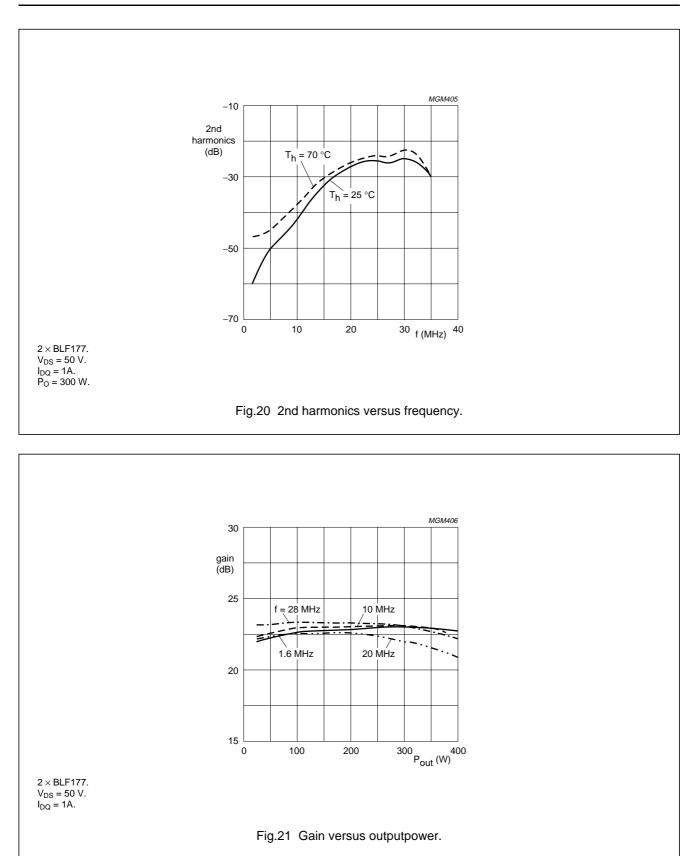
2. American Technical Ceramics type 100B or capacitor of same quality.

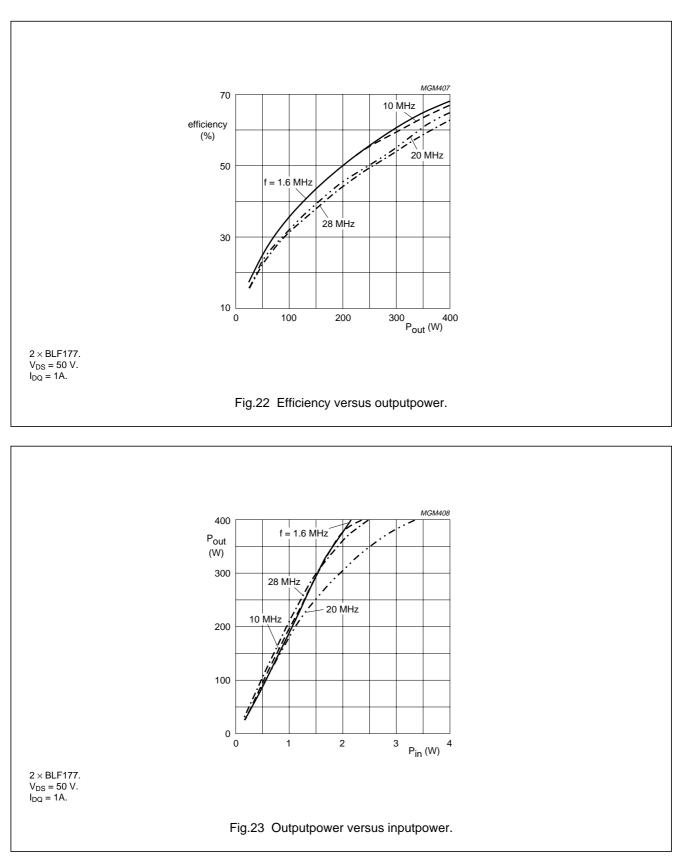


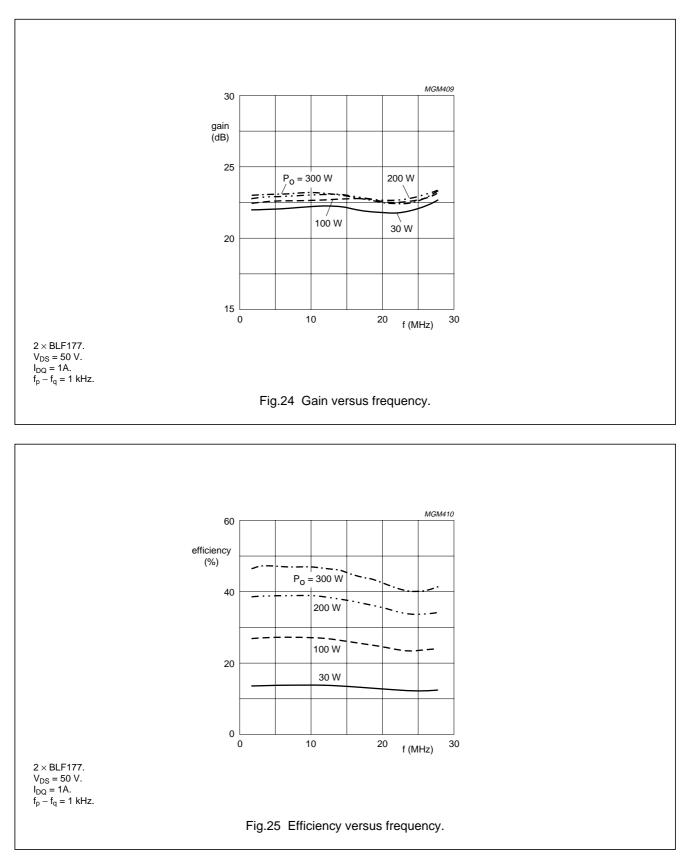


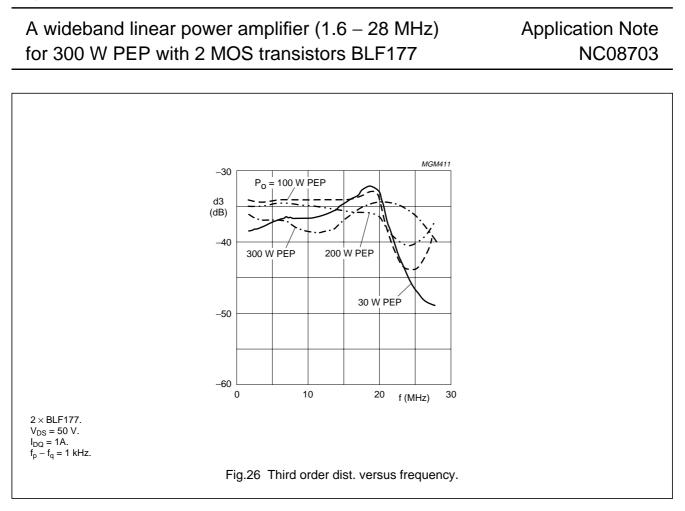


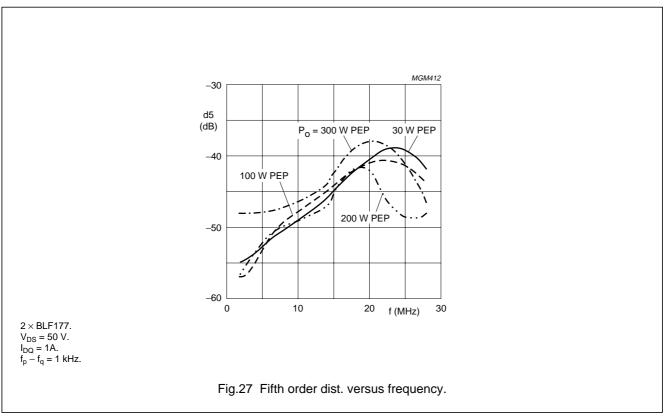


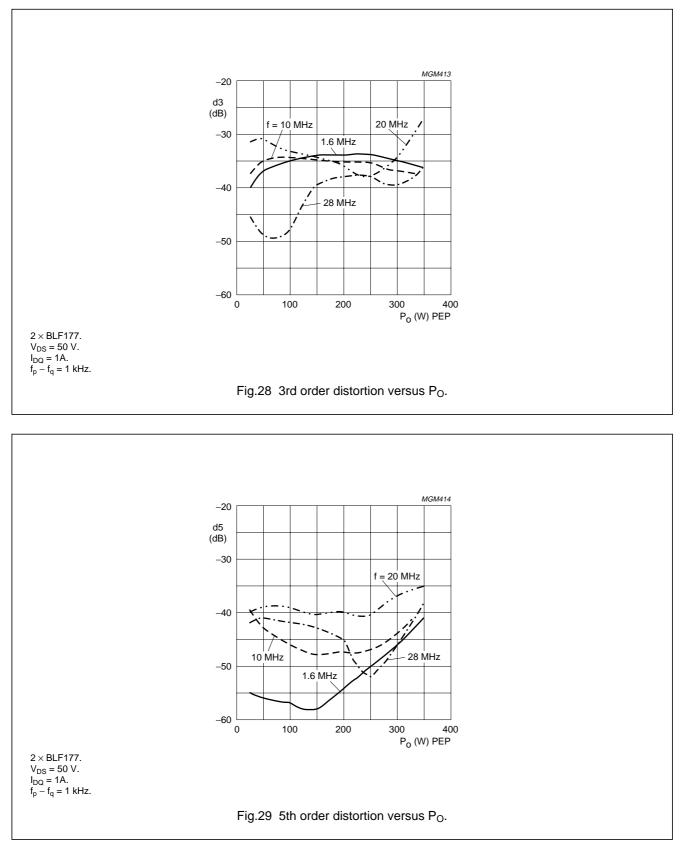


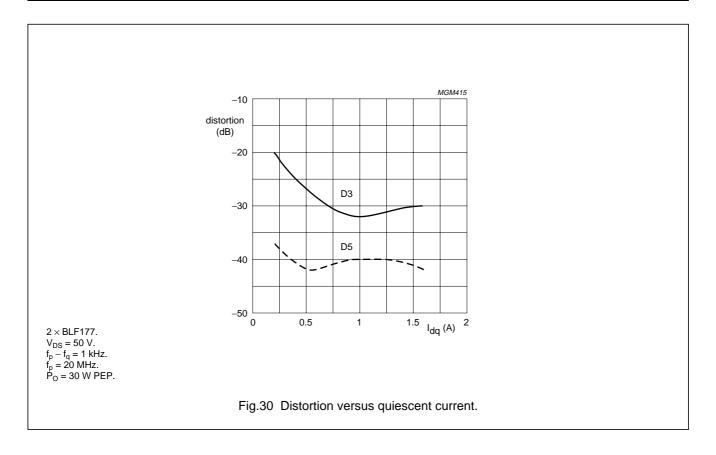












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